

## 8-Channel Serial-to-Parallel Converter with High-Voltage Push-Pull Outputs, Polarity, Hi-Z and Short-Circuit Detect

### Features

- Up to 250V Output Voltage
- Low-power Level Shifting from 5V to 250V
- Shift Register Speed:
  - 8 MHz at  $V_{DD} = 5V$
- Latched Data Outputs
- Output Polarity and Blanking
- Output Short-circuit Detect
- Output High-Z (Hi-Z) Control
- CMOS-compatible Inputs

### Applications

- Piezoelectric Transducer Driver
- Braille Driver
- Weaving Applications
- Printer Drivers
- Microelectromechanical Systems Applications
- Displays

### General Description

The HV513 is a low-voltage to high-voltage serial-to-parallel converter with eight high-voltage push-pull outputs. This device is designed to drive small capacitive loads such as piezoelectric transducers. It can also be used in any application requiring multiple high-voltage outputs with medium-current source-and-sink capabilities.

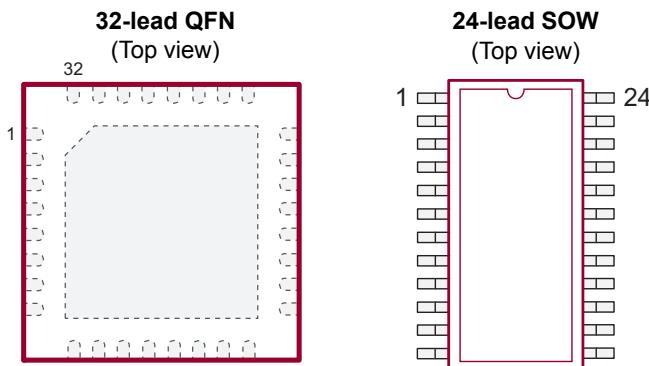
The device consists of an 8-bit Shift register, eight latches and control logic to perform the polarity select and blanking of the outputs. Data is shifted through the Shift register on the low-to-high transition of the clock. A data output buffer is provided for cascading devices. The operation of the Shift register is not affected by the latch enable ( $\overline{LE}$ ), blanking ( $\overline{BL}$ ), polarity ( $\overline{POL}$ ) and Hi-Z control inputs. The transfer of data from the Shift register to the latch occurs when the  $\overline{LE}$  is high. The data in the latch is stored when  $\overline{LE}$  is low. A Hi-Z pin is provided to set all the outputs in a High-Z state.

All outputs have short-circuit protection that detects if the outputs have reached the required output state. If an output does not track the required state, then the SHORT pin will be low. This output will pulse low during the output transition period under normal operation. See [Figure 3-2](#) for details.

All outputs will have a break-before-make circuitry to reduce crossover current during output state changes.

The  $\overline{POL}$ ,  $\overline{BL}$ ,  $\overline{LE}$  and  $\overline{Hi-Z}$  inputs have an internal pull-up resistor.

### Package Types



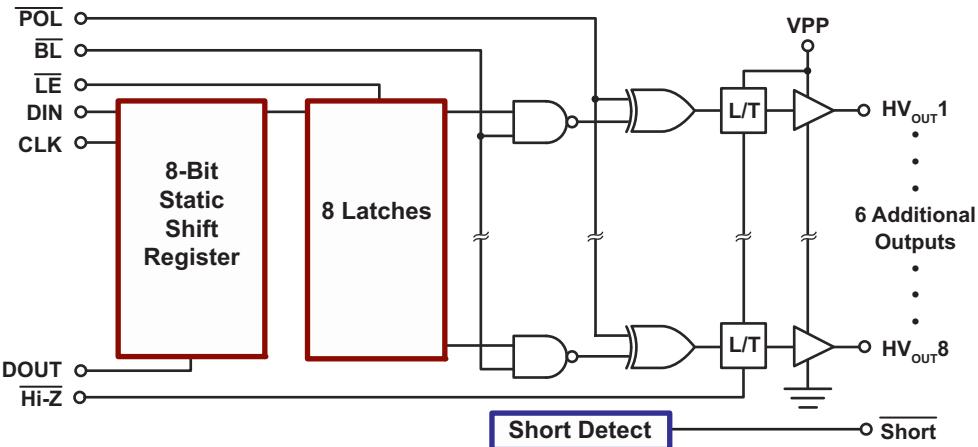
See [Table 2-1](#) and [Table 2-2](#) for pin information.

# HV513

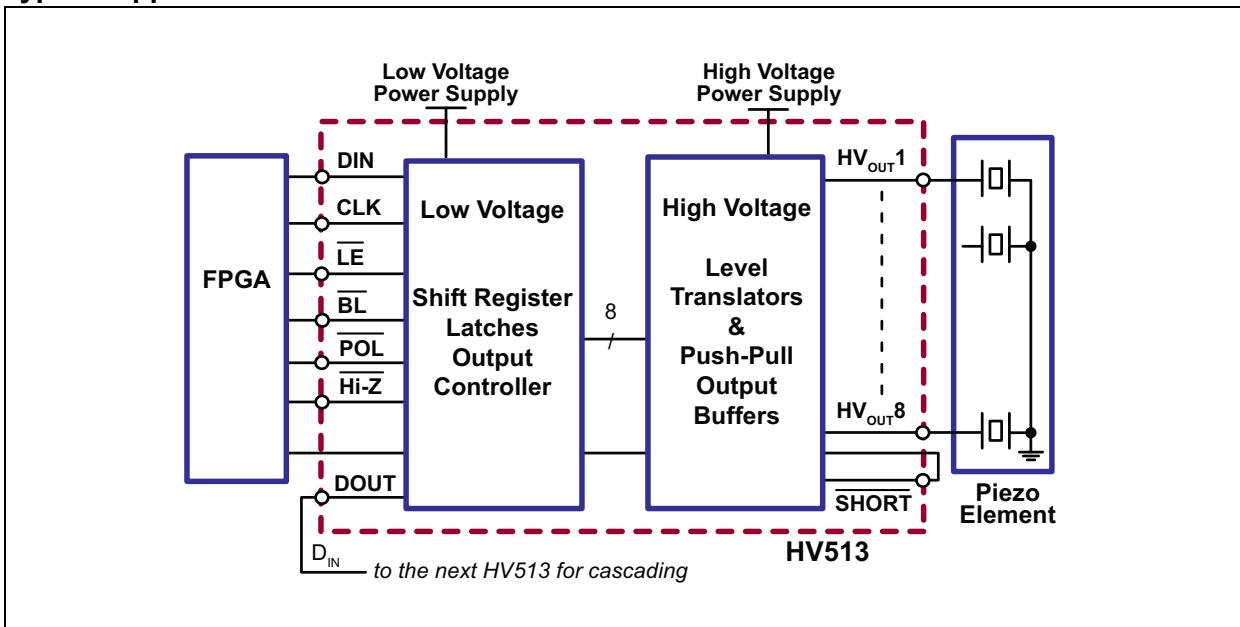
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## Functional Block Diagram



## Typical Application Circuit



## 1.0 ELECTRICAL CHARACTERISTICS

### Absolute Maximum Ratings†

Logic Supply Voltage, $V_{DD}$ .....	.....	-0.5V to +6V
High-voltage Supply, $V_{PP}$ .....	.....	$V_{DD}$ to +275V
Logic Input Levels .....	.....	-0.5V to $V_{DD}$ +0.5V
Ground Current ( <b>Note 1</b> ) .....	.....	0.3A
High-voltage Supply Current ( <b>Note 1</b> ) .....	.....	0.25A
Maximum Junction Temperature, $T_J(MAX)$ .....	.....	+125°C
Storage Temperature, $T_S$ .....	.....	-65°C to +150°C
Continuous Total Power Dissipation:		
32-lead QFN ( <b>Note 2</b> ) .....	.....	750 mW
24-lead SOW ( <b>Note 2</b> ) .....	.....	750 mW

† **Notice:** Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

**Note 1:** Connection to all power and ground pads is required. Duty cycle is limited by the total power dissipated in the package.

**2:** For operations above 25°C ambient, derate linearly to 85°C at 12 mW/°C.

### RECOMMENDED OPERATING CONDITIONS

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
Logic Supply Voltage	$V_{DD}$	4.5	5	5.5	V	
High-voltage Supply Voltage	$V_{PP}$	50	—	250	V	<b>Note 1</b>
High-level Input Voltage	$V_{IH}$	$V_{DD}-0.9V$	—	$V_{DD}$	V	
Low-level Input Voltage	$V_{IL}$	0	—	0.9	V	
Operating Junction Temperature	$T_J$	-40	—	+85	°C	

**Note 1:** The output may not switch below the minimum  $V_{PP}$ .

## DC ELECTRICAL CHARACTERISTICS

**Electrical Specifications:** Over typical operating conditions unless otherwise specified,  $T_J = 25^\circ\text{C}$ .

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
$V_{DD}$ Supply Current	$I_{DD}$	—	—	4	mA	$f_{CLK} = 8 \text{ MHz}$ , $\overline{LE} = \text{Low}$
Quiescent $V_{DD}$ Supply Current	$I_{DDQ}$	—	—	0.1	mA	All $V_{IN} = V_{DD}$
		—	—	2	mA	All $V_{IN} = 0V$
High-voltage Supply Current	$I_{PP}$	—	—	100	$\mu\text{A}$	$V_{PP} = 250\text{V}$ , $f_{OUT} = 300 \text{ Hz}$ , no load
Quiescent $V_{PP}$ Supply Voltage	$I_{PPQ}$	—	—	100	$\mu\text{A}$	$V_{PP} = 240\text{V}$ , outputs are static
High-level Logic Input Current	$I_{IH}$	—	—	10	$\mu\text{A}$	$V_{IH} = V_{DD}$
Low-level Logic Input Current	$I_{IL}$	—	—	-10	$\mu\text{A}$	$V_{IL} = 0V$
		—	—	-350	$\mu\text{A}$	$V_{IL} = 0V$ , for inputs with pull-up resistors
High-level Output	$HV_{OUT}$	$V_{OH}$	140	—	—	$V_{PP} = 200\text{V}$ , $I_{HVOUT} = -20 \text{ mA}$
	Data Out		$V_{DD} - 1V$	—	—	$V_{DOUT} = -0.1 \text{ mA}$
Low-level Output	$HV_{OUT}$	$V_{OL}$	—	—	60	$V_{DD} = 4.5\text{V}$ , $I_{HVOUT} = 20 \text{ mA}$
	Data Out		—	—	1	$V_{DOUT} = -0.1 \text{ mA}$

## AC ELECTRICAL CHARACTERISTICS

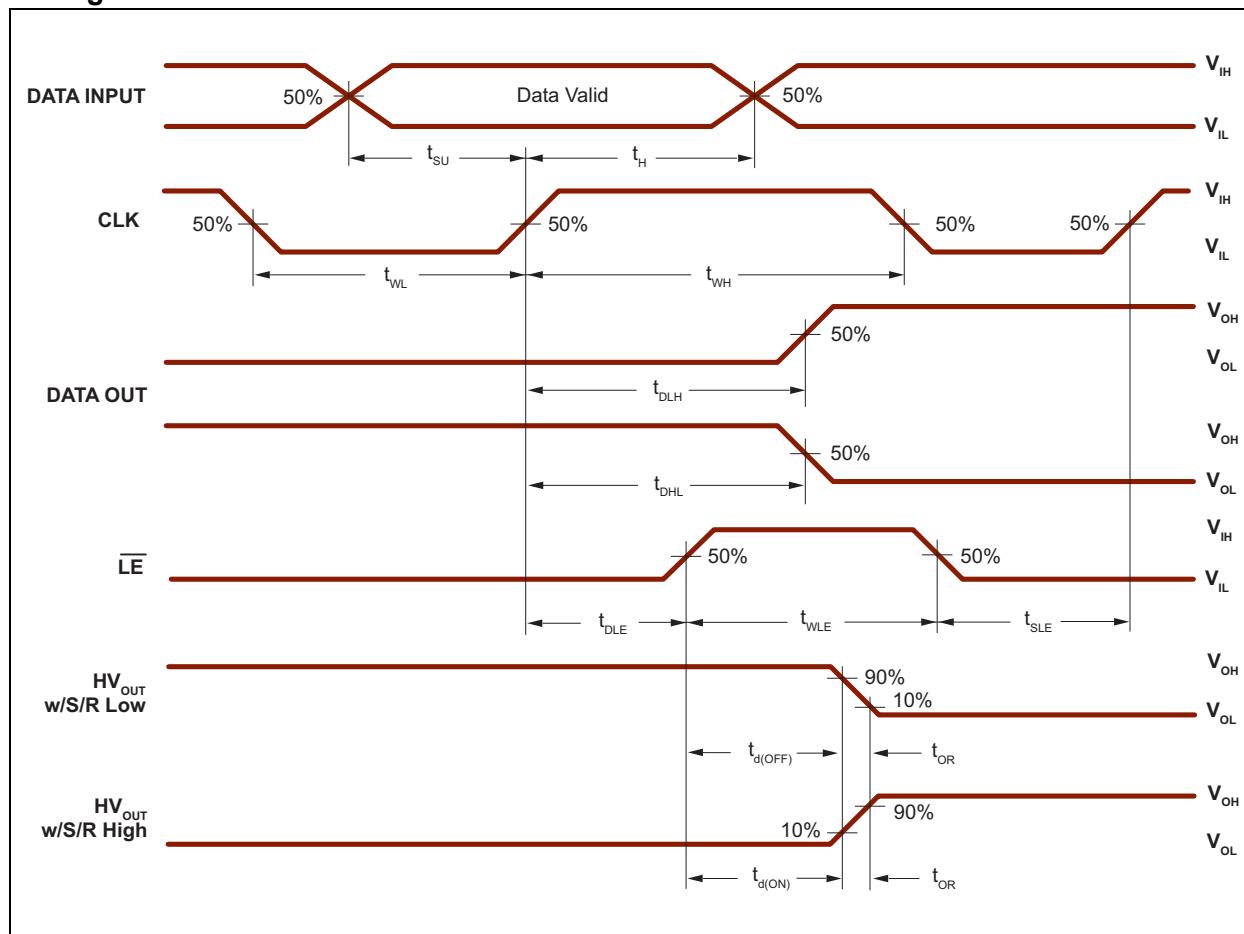
**Electrical Specifications:** Over typical operating conditions unless otherwise specified,  $T_J = 25^\circ\text{C}$ .

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
Clock Frequency	$f_{CLK}$	0	—	8	MHz	
Output Switching Frequency (SOA Limited)	$f_{OUT}$	—	300	—	Hz	$C_L = 50 \text{ nF}$ , $V_{PP} = 200\text{V}$
Clock Width High and Low	$t_{WL}, t_{WH}$	62	—	—	ns	
Data Set-up Time before Clock Rises	$t_{SU}$	15	—	—	ns	
Data Hold Time after Clock Rises	$t_H$	30	—	—	ns	
Latch Enable Pulse Width	$t_{WLE}$	80	—	—	ns	
Latch Enable Delay Time after Rising Edge of Clock	$t_{DLE}$	35	—	—	ns	
Latch Enable Set-up Time before Clock Rises	$t_{SLE}$	40	—	—	ns	
$HV_{OUT}$ Rise/fall Time	$t_{OR}, t_{OF}$	—	—	1000	$\mu\text{s}$	$C_L = 100 \text{ nF}$ , $V_{PP} = 200\text{V}$
Delay Time for Output to Start Rise/fall	$t_{dON/OFF}$	—	—	500	ns	
Delay Time Clock to Data Low to High	$t_{DLH}$	—	—	110	ns	$C_L = 15 \text{ pF}$
Delay Time Clock to Data High to Low	$t_{DHL}$	—	—	110	ns	$C_L = 15 \text{ pF}$
All Logic Inputs	$t_r, t_f$	—	—	5	ns	
Output Short-circuit Detection	$t_{SD}$	—	—	500	ns	$C_L = 15 \text{ pF}$ , short to output fall of SHORT
Output Short-circuit Clear	$t_{SC}$	—	—	3000	ns	Short clear to output rise of SHORT
Output High-Z State	$t_{HI-Z}$	—	—	500	ns	

## TEMPERATURE SPECIFICATIONS

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
<b>TEMPERATURE RANGE</b>						
Operating Junction Temperature	$T_J$	-40	—	+85	°C	
Maximum Junction Temperature	$T_{J(MAX)}$	—	—	+125	°C	
Storage Temperature	$T_S$	-65	—	+150	°C	
<b>PACKAGE THERMAL RESISTANCE</b>						
32-lead QFN	$\theta_{JA}$	—	22	—	°C/W	
24-lead SOW	$\theta_{JA}$	—	44	—	°C/W	

## Timing Waveforms



## 2.0 PIN DESCRIPTION

The details on the pins of HV513 32-lead QFN and 24-lead SOW packages are listed on [Table 2-1](#) and [Table 2-2](#), respectively. Refer to [Package Types](#) for the location of pins.

**TABLE 2-1: 32-LEAD QFN PIN FUNCTION TABLE**

Pin Number	Pin Name	Description
1	NC	No connection
2	NC	No connection
3	NC	No connection
4	LGND	Low-voltage ground
5	HVGND	High-voltage ground
6	HVGND	High-voltage ground
7	NC	No connection
8	NC	No connection
9	HVOUT1	High-voltage push-pull output
10	HVOUT2	High-voltage push-pull output
11	HVOUT3	High-voltage push-pull output
12	HVOUT4	High-voltage push-pull output
13	HVOUT5	High-voltage push-pull output
14	HVOUT6	High-voltage push-pull output
15	HVOUT7	High-voltage push-pull output
16	HVOUT8	High-voltage push-pull output
17	NC	No connection
18	NC	No connection
19	VPP	High-voltage supply
20	VPP	High-voltage supply
21	VDD	Logic supply voltage
22	DOUT	Data output
23	NC	No connection
24	NC	No connection
25	BL	Blanking. A logic input low sets all HVOUTs low.
26	NC	No connection
27	POL	Polarity bar input logic
28	CLK	Clock. Shift registers shift data on the rising edge of input clock.
29	LE	Latch enable bar input logic
30	SHORT	If output does not reach its required state, a logic '0' will be asserted at the SHORT pin.
31	Hi-Z	High-impedance pin. Logic input low sets all outputs in a high-impedance state.
32	DIN	Data input

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**TABLE 2-2: 24-LEAD SOW PIN FUNCTION TABLE**

Pin Number	Pin Name	Description
1	NC	No connection
2	VDD	Logic supply voltage
3	DOUT	Data output
4	<u>BL</u>	Blanking. A logic input low sets all HVOUTs low.
5	<u>POL</u>	Polarity bar input logic
6	CLK	Clock. Shift registers shift data on the rising edge of input clock.
7	<u>LE</u>	Latch enable bar input logic
8	<u>SHORT</u>	If output does not reach its required state, a logic '0' will be asserted at the <u>SHORT</u> pin.
9	<u>Hi-Z</u>	High-impedance pin. Logic input low sets all outputs in a high-impedance state.
10	DIN	Data input
11	LGND	Low-voltage ground
12	NC	No connection
13	HVGND	High-voltage ground
14	HVGND	High-voltage ground
15	HVOUT1	High-voltage push-pull output
16	HVOUT2	High-voltage push-pull output
17	HVOUT3	High-voltage push-pull output
18	HVOUT4	High-voltage push-pull output
19	HVOUT5	High-voltage push-pull output
20	HVOUT6	High-voltage push-pull output
21	HVOUT7	High-voltage push-pull output
22	HVOUT8	High-voltage push-pull output
23	VPP	High-voltage supply
24	VPP	High-voltage supply

### 3.0 FUNCTIONAL DESCRIPTION

Follow the steps in [Table 3-1](#) to power up and power down the HV513.

**TABLE 3-1: POWER-UP AND POWER-DOWN SEQUENCE**

Power-up						Power-down		
Step	Description					Step	Description	
1	Connect ground.					1	Remove $V_{PP}$ .	
2	Apply $V_{DD}$ .					2	Remove all inputs.	
3	Set all inputs (Data, CLK, Enable, etc.) to a known state.					3	Remove $V_{DD}$ .	
4	Apply $V_{PP}$ .					4	Disconnect ground.	

**TABLE 3-2: TRUTH FUNCTION TABLE**

Function	Inputs						Outputs		
	Data	CLK	$\overline{LE}$	$\overline{BL}$	POL	Hi-Z	Shift Register	High-voltage Output	Data Out
1	2...8	1	2...8	*	*	*	*	*	*
All On	X	X	X	L	L	H	*	* ... *	*
All Off	X	X	X	L	H	H	*	* ... *	*
Invert Mode	X	X	L	H	L	H	*	* ... *	*
Load S/R	H or L	↑	L	H	H	H	H or L	* ... *	*
Store Data in Latches	X	X	L	H	H	H	*	* ... *	*
	X	X	L	H	L	H	*	* ... *	*
Transparent Latch Mode	L	↑	H	H	H	H	L	* ... *	*
	H	↑	H	H	H	H	H	* ... *	*
Outputs Hi-Z	X	X	X	X	X	L	*	* ... *	High-impedance outputs
Outputs On	X	X	X	X	X	H	*	* ... *	*

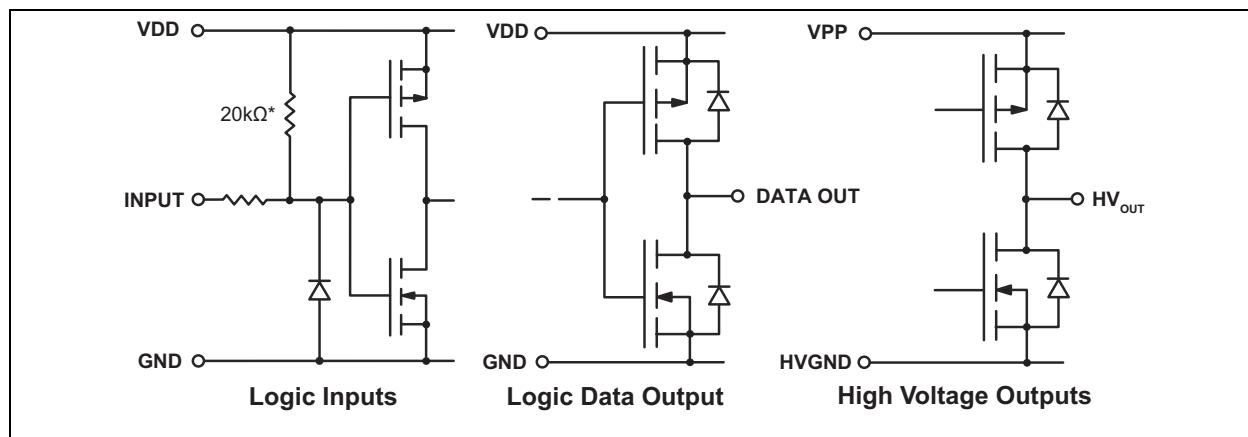
**Note:** H = High-logic level

L = Low-logic level

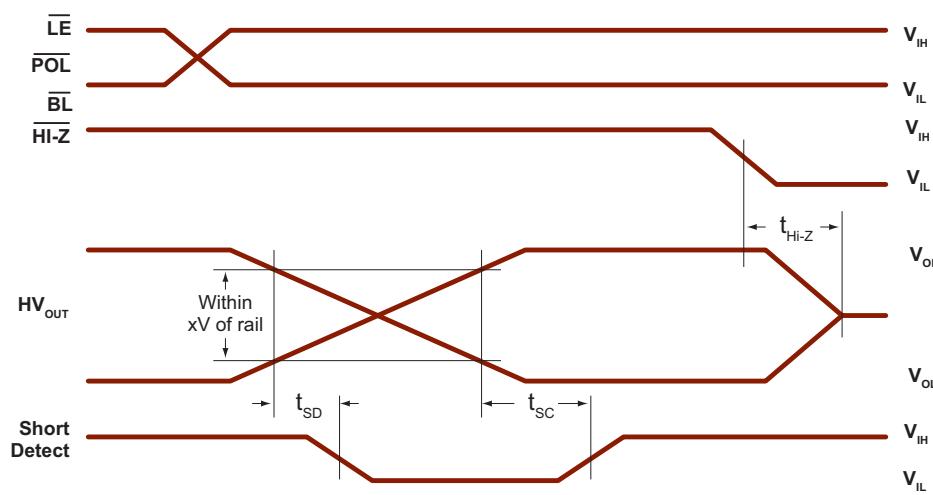
X = Irrelevant

↑ = Low-to-high transition

\* = Dependent on the previous stage's state before the last CLK or last  $\overline{LE}$  high



**FIGURE 3-1: Input and Output Equivalent Circuits.**



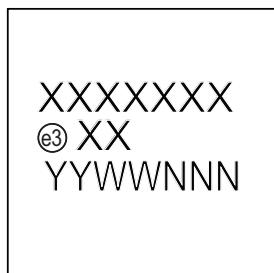
- Note 1:** For  $V_{PP}$  greater than 150V, the short detect output will flag short conditions. There are two possibilities:  
**Case 1:**  $HV_{OUT}$  is higher than 10V when expected low.  
**Case 2:**  $HV_{OUT}$  is lower than  $V_P - 100V$  when expected high.
- 2:** For  $V_{PP}$  greater than 150V, the short detect output will stay clear. There are two possibilities:  
**Case 1:**  $HV_{OUT}$  is lower than 2V when expected low.  
**Case 2:**  $HV_{OUT}$  is higher than  $V_{PP} - 60V$  when expected high.

**FIGURE 3-2:** Short-circuit Detect Detail Timing.

## 4.0 PACKAGE MARKING INFORMATION

### 4.1 Packaging Information

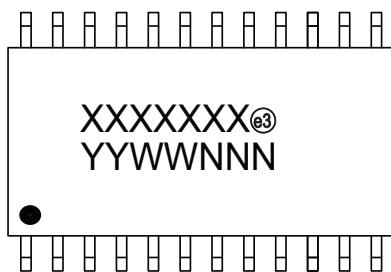
32-lead QFN



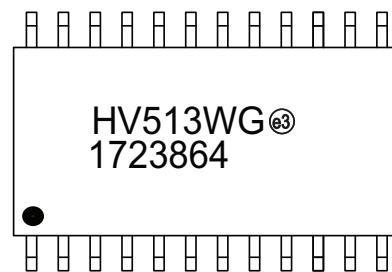
Example



24-lead SOW



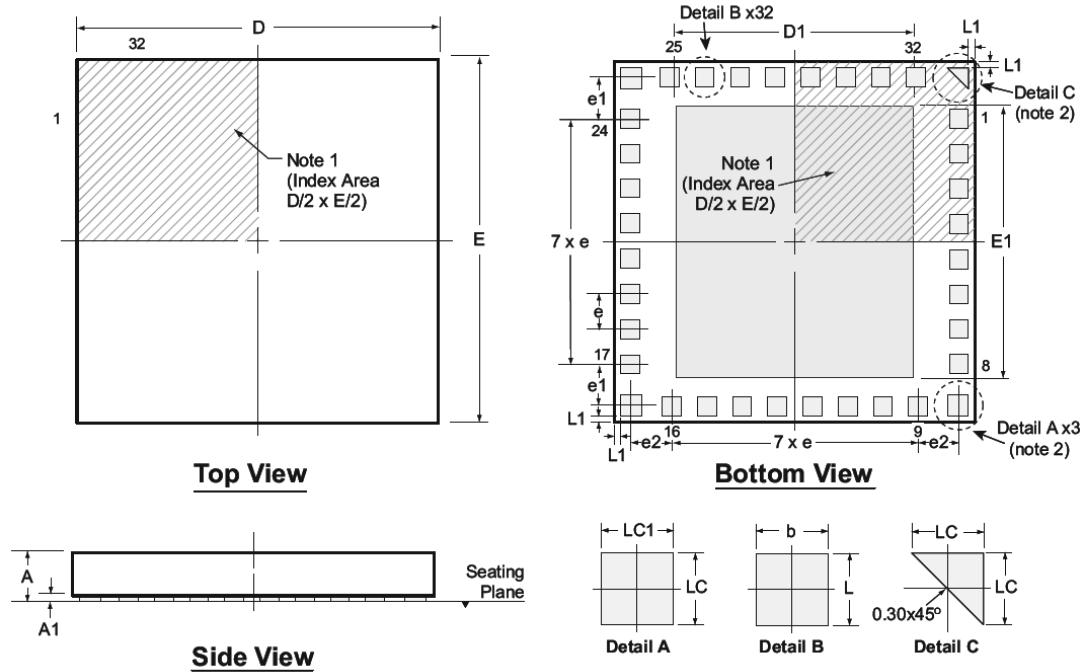
Example



<b>Legend:</b>	XX...X Product Code or Customer-specific information
Y	Year code (last digit of calendar year)
YY	Year code (last 2 digits of calendar year)
WW	Week code (week of January 1 is week '01')
NNN	Alphanumeric traceability code
(e3)	Pb-free JEDEC® designator for Matte Tin (Sn)
*	This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.
<b>Note:</b>	In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for product code or customer-specific information. Package may or not include the corporate logo.

## 32-Lead QFN Package Outline (K7)

**6.00x6.00mm body, 0.80mm height (max), 0.50mm pitch**



Note: For the most current package drawings, see the Microchip Packaging Specification at [www.microchip.com/packaging](http://www.microchip.com/packaging).

**Notes:**

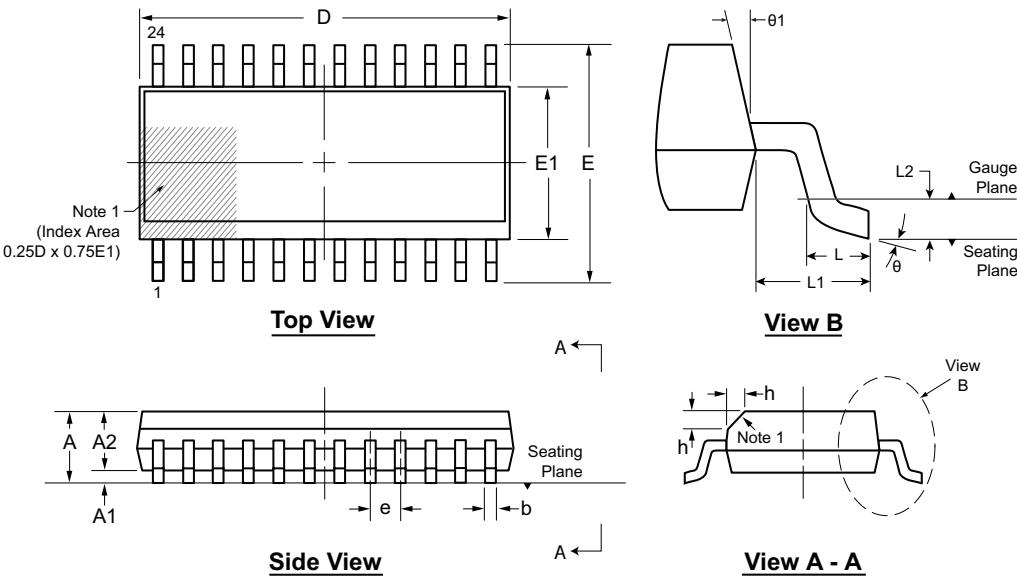
1. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier, an embedded metal marker, or a printed indicator.
2. The 4 corner pads are for mechanical placement only, they are not internally connected.

Symbol	A	A1	b	D	D1	E	E1	e	e1	e2	L	L1	LC	LC1
Dimension (mm)	MIN	0.70	0.00	0.20	5.90	3.20	5.90	4.30	0.50 BSC	1.00 REF	0.975 REF	0.20	0.10 REF	0.20
	NOM	0.75	-	0.30	6.00	3.30	6.00	4.40				0.30		0.30
	MAX	0.80	0.05	0.40	6.10	3.40	6.10	4.50				0.40		0.45

*Drawings not to scale.*

## 24-Lead SOW (Wide Body) Package Outline (WG)

15.40x7.50 body, 2.65mm height (max), 1.27mm pitch



Note: For the most current package drawings, see the Microchip Packaging Specification at [www.microchip.com/packaging](http://www.microchip.com/packaging).

**Note:**

1. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.

Symbol	A	A1	A2	b	D	E	E1	e	h	L	L1	L2	θ	θ1	
Dimension (mm)	MIN	2.15*	0.10	2.05	0.31	15.20*	9.97*	7.40*	1.27 BSC	0.25	0.40	1.40 REF	0.25 BSC	0°	5°
	NOM	-	-	-	-	15.40	10.30	7.50		-	-			-	-
	MAX	2.65	0.30	2.55*	0.51	15.60*	10.63*	7.60*		0.75	1.27			8°	15°

JEDEC Registration MS-013, Variation AD, Issue E, Sep. 2005.

\* This dimension is not specified in the JEDEC drawing.

Drawings are not to scale.

# HV513

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## NOTES:

## APPENDIX A: REVISION HISTORY

### Revision A (October 2017)

- Converted Supertex Doc # DSFP-HV513 to Microchip DS20005846A
- Removed “HVCMOS® Technology” in the Features section
- Changed the package marking format
- Removed the 32-lead (6 x 6) WQFN K7 M935 media type
- Changed the quantity of the 32-lead (6 x 6) WQFN K7 package from 400/Tray to 490/Tray
- Made minor changes throughout the document

# HV513

## PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

PART NO.	XX	-	X	-	X	Examples:
Device	Package Options		Environmental		Media Type	
Device: HV513 = 8-Channel Serial-to-Parallel Converter with High-Voltage Push-Pull Outputs, Polarity, Hi-Z and Short-Circuit Detect						
Packages:	K7	= 32-lead (6 x 6) WQFN				a) HV513K7-G:
	WG	= 24-lead SOW				8-Channel Serial-to-Parallel Converter with High-Voltage Push-Pull Outputs, Polarity, Hi-Z and Short-Circuit Detect, 32-lead (6 x 6) WQFN, 490/Tray
Environmental:	G	= Lead (Pb)-free/RoHS-compliant Package				b) HV513WG-G:
Media Types:	(blank)	= 490/Tray for a K7 package				8-Channel Serial-to-Parallel Converter with High-Voltage Push-Pull Outputs, Polarity, Hi-Z and Short-Circuit Detect, 24-lead SOW, 1000/Reel
		= 1000/Reel for a WG package				

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ISBN: 978-1-5224-2263-1



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